

SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

SMA3117 — ^{Silicon MMIC} Wideband Amplifier

Features

- High Gain : Gp=33.5dB typ. @2.2GHz
- Wideband response : fu=3.0GHz
- Low current : ICC=22.7mA typ.
- High output power : Po(1dB)=5.7dBm
- Port impedance : input/output 50Ω
- Halogen free compliance

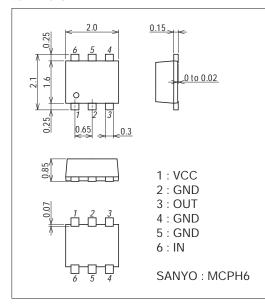
Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Supply Voltage	VCC		6	V
Circuit Current	ICC		40	mA
Allowable Power Dissipation	PD		280	mW
Operating Temperature	Topr		-40 to +85	°C
Storage Temperature	Tstg		-55 to +150	°C

Package Dimensions

unit : mm (typ) 7022A-018



Product & Package Information

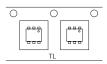
• Package : MCPH6

- : SC-88, SOT-363
- Minimum Packing Quantity : 3,000pcs/reel

Packing Type: TL

• JEITA, JEDEC

Marking





Recommended Operating Conditions at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
	Symbol	Conditions	min	typ	max	Unit
Supply Voltage	VCC		4.5	5	5.5	V
Operating Ambient Temperature	Topr		-40	+25	+85	°C

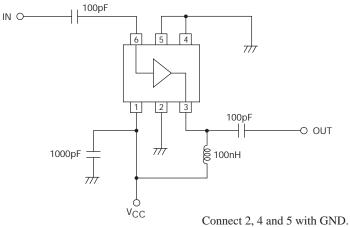
Electrical Characteristics at Ta=25°C, V_{CC}=5V, Zs=ZL=50 Ω

Parameter	Symbol	Symbol Conditions	Ratings			Linit
	Symbol		min	typ	max	- Unit
Circuit Current	ICC		18.5	22.7	28.0	mA
Power Gain	Gp	f=1GHz	29.5	31.2	32.5	dB
		f=2.2GHz	30.5	33.5	35.5	
Isolation	ISL	f=1GHz	35.0	37.6		dB
		f=2.2GHz	34.0	36.5		
Input Return Loss	RLin	f=1GHz	9.0	11.2		dB
		f=2.2GHz	4.5	6.0		
Output Return Loss	RLout	f=1GHz	11.0	14.3		dB
		f=2.2GHz	12.0	16.3		
Noise Figure	NF	f=1GHz		4.1	5.0	dB
		f=2.2GHz		3.9	5.0	
Gain 1dB Compression Output Power *1	D. (1.1D)	f=1GHz	7.5	9.8		dBm
	Po(1dB)	f=2.2GHz	3.7	5.7		
Upper Limit Operating Frequency *1	fu	3dB down below flat gain at f=1GHz		3.0		GHz

*1 : On evaluation board

Note) Pay attention to handling since it is liable to be affected by static electricity due to the high frequency process adopted.

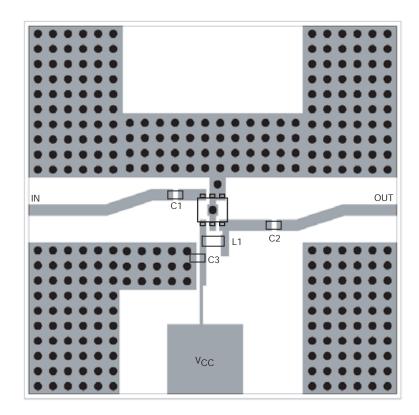
Test Circuit



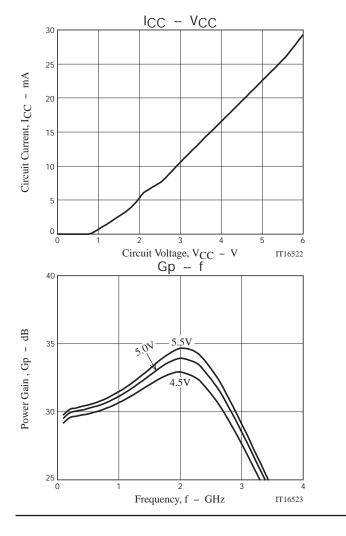
2, 4 and 5 with GND.

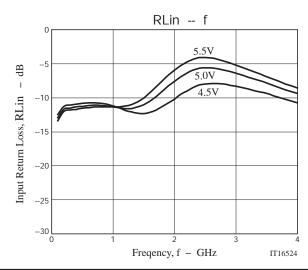
IT15580

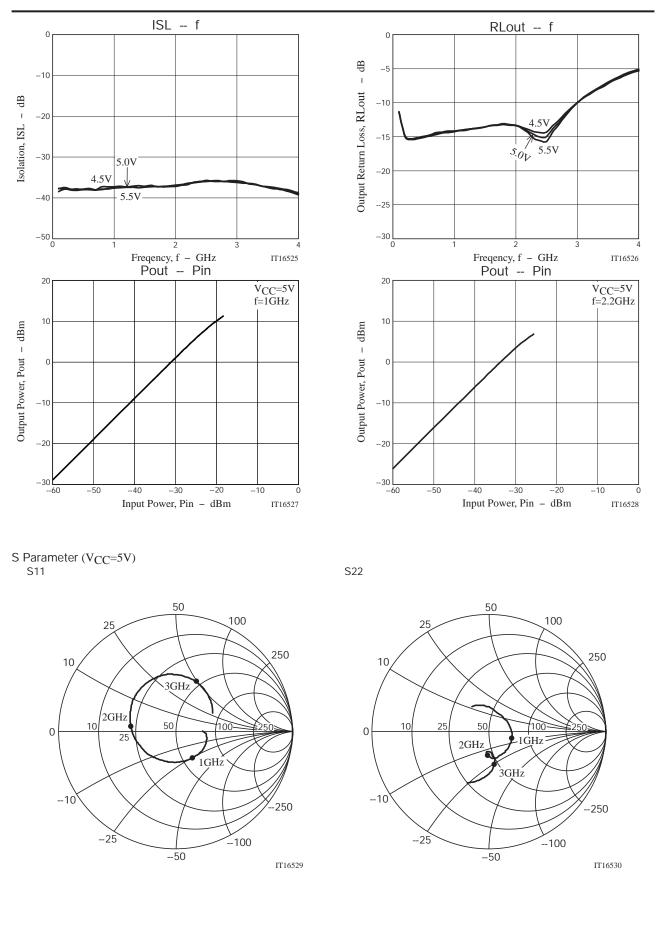
Evaluation Board



Symbol	Value
C1, C2	100pF
C3	1000pF
L1	100nH







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